#### The Embedded I/O Company



# **TXMC895**

#### Four Channel 10/100/1000 Mbit/s Ethernet

Version 1.0

#### **User Manual**

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Ehlbeek 15a 30938 Burgwedel fon 05139-9980-0 fax 05139-9980-49

www.powerbridge.de info@powerbridge.de

**TEWS TECHNOLOGIES GmbH** 

Am Bahnhof 7 25469 Halstenbek, Germany Phone: +49 (0) 4101 4058 0 Fax: +49 (0) 4101 4058 19

e-mail: info@tews.com www.tews.com



#### **TXMC895-10R**

Four Channel 10/100/1000 Mbit/s Ethernet, Intel I210IT, RJ45

(RoHS compliant)

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### 1 **Product Description**

The TXMC895 is a Switched Mezzanine Card (XMC) compatible module providing a four channel Ethernet 10Base-T / 100Base-TX / 1000Base-T interface.

A PCIe Switch provides access to the Intel I210IT Gigabit Ethernet controllers. Each Ethernet interface supports 10, 100 and 1000 Mbit/s transmission rates and is equipped with a 16 Mbit Serial Flash to support PXE and iSCSI boot.

The four Ethernet interfaces of the TXMC895 are capable of performing an auto negotiation algorithm which allows both link-partners to determine the best link-parameters. The TXMC895 supports IEEE 1588/802.1AS Precision Time Protocol (PTP) and IEEE 802.1Qav Audio/Video Bridging (AVB) traffic shaping (with software extensions).

The TXMC895-10R provides four 10/100/1000 Mbit/s Ethernet connections via front panel RJ45 connectors.

All ports are galvanically isolated from the Ethernet controllers and LEDs on the board indicate the different network activities.

The module meets the requirements to operate in extended temperature range from -40°C to +85°C.

#### **Software Support:**

- Software support for Intel I210IT at www.intel.com
- o For operating systems not supported by Intel, please contact TEWS.

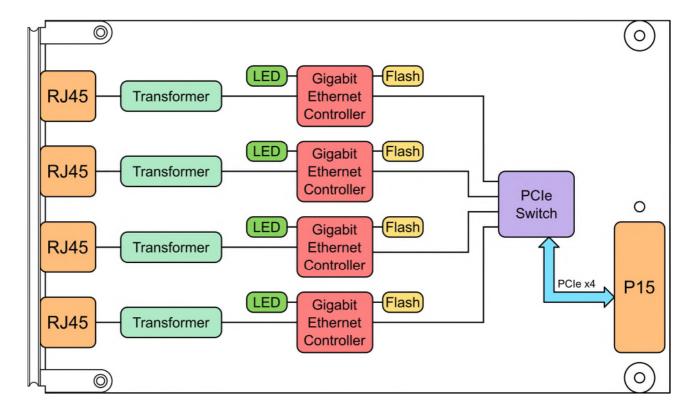


Figure 1-1: Block Diagram



# 2 Technical Specification

| XMC Interface        |  |  |  |
|----------------------|--|--|--|
| Mechanical Interface | Switched Mezzanine Card (XMC) Interface conforming to ANSI/VITA 42.0 Short single-width (124 mm x 74 mm) |  |  |
| Electrical Interface | x4 PCI Express (Specification 2.1) compliant interface conforming to ANSI/VITA 42.3                      |  |  |

| On Board Devices                    |  |  |  |
|-------------------------------------|--|--|--|
| PCIe Switch                         | PI7C9X2G608GP (Diodes Incorporated)    |  |  |
| Gigabit Ethernet Controllers        | For each interface: I210-IT (Intel)    |  |  |
| 16 Mbit Serial Flashes for Boot ROM | For each interface: W25Q16JV (Winbond) |  |  |

| I/O Interface      |   |  |
|--------------------|---|--|
| Number of Channels | 4   |  |
| I/O Standards      | 1000Base-T<br>100Base-TX<br>10Base-T        |  |
| I/O Connector      | RJ45 (TE Connectivity 406732 or compatible) |  |

| Physical Data      |  |   |  |
|--------------------|--|---|--|
|                    | 600mA typical @ VPWR = +5V (four channel, no link)   |   |  |
|                    | app. additional 10mA to 100mA per link   |   |  |
| Power Requirements |  |   |  |
|                    | 270mA typical @ VPWR = +12V (four channel, no link)  |   |  |
|                    | app. additional 4.5mA to 45mA per link   |   |  |
| Temperature Bonce  | Operating  | -40°C to +85°C (constant airflow of 2m/s is required) |  |
| Temperature Range  | Storage  | -40°C to +85°C  |  |
|                    | 581000 h   |   |  |
| MTBF               | MTBF values shown are based on calculation according to MIL-HDBK-217F and MIL-HDBK-217F Notice 2; Environment: G <sub>B</sub> 20°C.  |   |  |
|                    | The MTBF calculation is based on component FIT rates provided by the component suppliers. If FIT rates are not available, MIL-HDBK-217F and MIL-HDBK-217F Notice 2 formulas are used for FIT rate calculation. |   |  |
| Humidity           | 5 – 95 % non-condensing  |   |  |
| Weight             | 72 g   |   |  |

Table 2-1: Technical Specification



# 3 Handling and Operation Instructions

#### 3.1 ESD Protection



This XMC module is sensitive to static electricity. Packing, unpacking and all other module handling has to be done with appropriate care.

## 3.2 Power Dissipation



This XMC module requires adequate forced air cooling!



# 4 PCI Express Interface

## 4.1 TXMC895 PCI Express Device Topology

The TXMC895 uses four Gigabit Ethernet Controllers (Intel I210-IT) each communicating via a PCIe Rev. 2.1 compliant x1 Interface.

To be able to access the Ethernet controllers they are connected to the x1 Downstream Ports of a PCle Switch (Diodes Incorporated PI7C9X2G608GP).

The x4 Upstream Port of the PCIe Switch is connected to the host system.

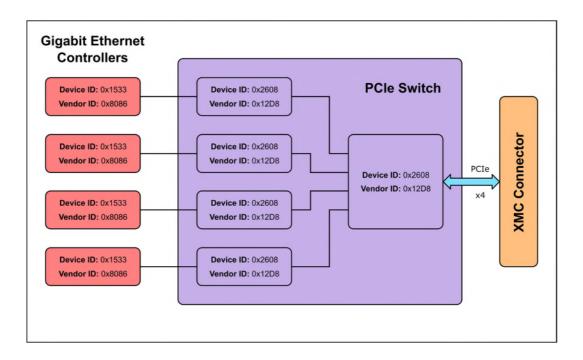


Figure 4-1: TXMC895 PCI Express Device Topology

# 4.2 TXMC895 PCI Express Memory and I/O Size Requirements

| PCIe Space Mapping | Four Channel<br>(Byte) | Two Channel<br>(Byte) |
|--------------------|------------------------|-----------------------|
| MEM                | 4M                     | 2M                    |
| I/O                | 16K                    | 8K                    |

Table 4-1: TXMC895 PCI Express Memory and I/O Size Requirements



# 4.3 I210 PCI Express Identifiers

| Vendor-ID           | 0x8086 (Intel)                 |  |  |
|---------------------|--------------------------------|--|--|
| Device-ID           | 0x1533 (I210-IT copper only)   |  |  |
| Class Code          | 0x020000 (Ethernet Controller) |  |  |
| Subsystem Vendor-ID | 0xFFFF                         |  |  |
| Subsystem Device-ID | 0x0000                         |  |  |

Table 4-2: I210 PCI Express Identifiers

# 4.4 I210 PCI Express Base Address Register Configuration

| PCIe Base Address Register<br>(Offset in PCIe Configuration<br>Space) | PCIe<br>Space<br>Mapping | Size<br>(Byte) | Description                      |
|---|--------------------------|----------------|----------------------------------|
| 0 (0x10)  | MEM                      | 128K           | Internal Registers               |
| 1 (0x14)  | -                        | -              | -                                |
| 2 (0x18)  | I/O                      | 32             | Internal Registers via I/O Space |
| 3 (0x1C)  | MEM                      | 16K            | MSI-X                            |

Table 4-3: I210 PCI Express Base Address Register Configuration



# 5 Ethernet Interface Status LEDs

The TXMC895 provides an individual Status LED for every Ethernet Interface. Due to the fact that XMCs are mounted upside-down on the carrier card the Status LEDs are visible on the back side of the TXMC895. A marking is placed close to each Status LED to indicate the Ethernet Port it corresponds to.

See table below for more details:

| Status LED Description   |   |  |
|--------------------------|---|--|
| OFF                      | No cable is connected or no link is established         |  |
| ON A link is established |   |  |
| BLINKING                 | Activity (the Ethernet Port transmits or receives data) |  |

Table 5-1: Status LED



# 6 Pin Assignment – I/O Connectors

### 6.1 RJ45 Connector

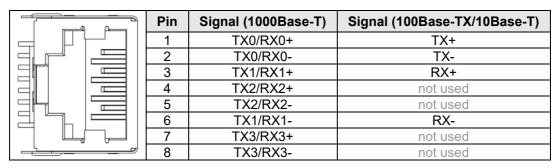


Table 6-1: RJ45 Connector